

BCM

Product Change Notice

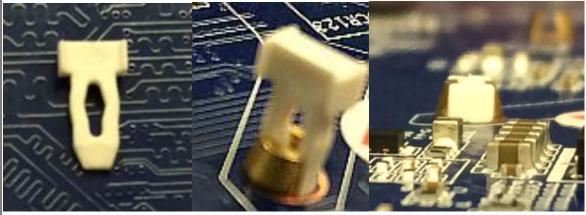
PCN Type: ■HW/SYS	$S/Kit \square BIOS/LAN/FV$	W □Package	e/Label □D	river/OS	□Acc.	□Others	Page: <u>1</u> of <u>1</u>
PCN Number: 71001-H1-006/		Revision: A		Date o	Date of Publication: 08/11/2016		
69036-S1-004							
PRODUCT NAME	PRODUCT PART#	OLD — RE	V. — NEW			REVISION	TYPE
MX1900J	71001-IA	1.3A	1.4	Hardw	are		
BI255-1900J	69036	1.2	1.3				

REASON OF CHANGE:

Improve the processors heatsink retention mechanism on the MX1900J board.

DESCRIPTION OF CHANGE:

Insert additional plastic retention cap into the heatsink's through-hole pin.



IMPACT OF CHANGE AND RECOMMEND ACTION:

This change has been thoroughly evaluated to ensure that there is no quality, reliability, functional, thermal or regulation implications to our customers.

BCM is not recommending our customers to perform additional qualification of these changes.

AFFECTED BY THIS CHANGE		
Specification	NO	
Packaging	NO	
Labeling	NO	
BIOS	NO	
Driver	NO	
Hardware	YES	

CUT IN DATE:

Date: August, 2016

OR **Lot#**:

*Cut in date is based on the current forecast.

Parts Disposition	Rework	As Is	Scrap
New Order	Χ		
In Process	Χ		
Finished Goods	Х		
RMA	Х		

This PCN had been QUALIFIED and APPROVED by BCM Engineering Department on 08/11/2016.

APPROVED BY

VP OF SALES	<approved></approved>	08/11/2016
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Signature Date

Doc#: F-G0-0-005G